FAIRCHILD
SEMICONDUCTOR™

MM74HC132
Quad 2-Input NAND Schmitt Trigger

General Description

The MM74HC132 utilizes advanced silicon-gate CMOS technology to achieve the low power dissipation and high noise immunity of standard CMOS, as well as the capability to drive 10 LS-TTL loads.

The 74HC logic family is functionally and pinout compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

■ Typical propagation delay: 12 ns
■ Wide power supply range: 2V–6V
■ Low quiescent current: 20 μA maximum (74HC Series)
■ Low input current: 1 μA maximum
■ Fanout of 10 LS-TTL loads
■ Typical hysteresis voltage: 0.9V at V_{CC}=4.5V

Ordering Code:

Order Number	Package Number	Package Description
MM74HC132M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HC132MX_NL	M14A	Pb-Free 14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HC132SJ	M14D	Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC132MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC132N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code. (Tape and Reel not available in N14A.)
Pb-Free package per JEDEC J-STD-020B.

Connection Diagram

Pin Assignment for DIP, SOIC, SOP, and TSSOP

Top View

Logic Diagram

$Y = \overline{AB}$
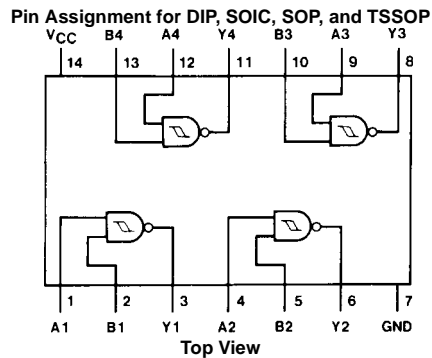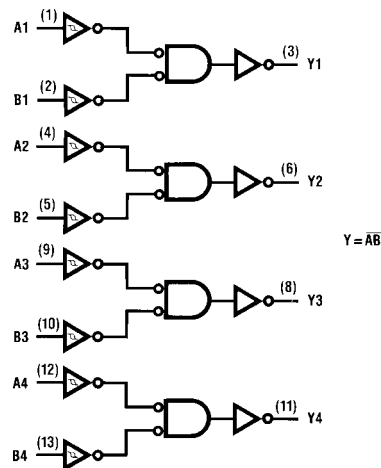
Absolute Maximum Ratings(Note 1)

(Note 2)

Supply Voltage (V_{CC})	−0.5 to +7.0V
DC Input Voltage (V_{IN})	−1.5 to V_{CC} +1.5V
DC Output Voltage (V_{OUT})	−0.5 to V_{CC} +0.5V
Clamp Diode Current (I_{IK}, I_{OK})	±20 mA
DC Output Current, per pin (I_{OUT})	±25 mA
DC V_{CC} or GND Current, per pin (I_{CC})	±50 mA
Storage Temperature Range (T_{STG})	−65°C to +150°C
Power Dissipation (P_D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T_L)	
(Soldering 10 seconds)	260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temperature Range (T_A)	−40	+125	°C

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: −12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions		V_{CC}	T_A = 25°C	T_A = -40 to 85°C	T_A = -40 to 125°C	Units
					Typ	Guaranteed Limits		
V_{T+}	Positive Going		Min	2.0V		1.0	1.0	1.0	V
	Threshold Voltage			4.5V		2.0	2.0	2.0	V
				6.0V		3.0	3.0	3.0	V
			Max	2.0V		1.5	1.5	1.5	V
				4.5V		3.15	3.15	3.15	V
				6.0V		4.2	4.2	4.2	V
V_{T-}	Negative Going		Min	2.0V		0.3	0.3	0.3	V
	Threshold Voltage			4.5V		0.9	0.9	0.9	V
				6.0V		1.2	1.2	1.2	V
			Max	2.0V		1.0	1.0	1.0	V
				4.5V		2.2	2.2	2.2	V
				6.0V		3.0	3.0	3.0	V
V_H	Hysteresis Voltage		Min	2.0V		0.2	0.2	0.2	V
				4.5V		0.4	0.4	0.4	V
				6.0V		0.5	0.5	0.5	V
			Max	2.0V		1.0	1.0	1.0	V
				4.5V		1.4	1.4	1.4	V
				6.0V		1.5	1.5	1.5	V
V_{OH}	Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}		2.0V	2.0	1.9	1.9	1.9	V
	Output Voltage	$|I_{OUT}| \le 20\ \mu A$		4.5V	4.5	4.4	4.4	4.4	V
		$V_{IN} = V_{IH}$ or V_{IL}		6.0V	6.0	5.9	5.9	5.9	V
		$|I_{OUT}| \le 4.0\ mA$		4.5V	4.2	3.98	3.84	3.7	V
		$|I_{OUT}| \le 5.2\ mA$		6.0V	5.7	5.48	5.34	5.2	V
V_{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}		2.0V	0	0.1	0.1	0.1	V
	Output Voltage	$|I_{OUT}| \le 20\ \mu A$		4.5V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL}		6.0V	0	0.1	0.1	0.1	V
		$|I_{OUT}| \le 4.0\ mA$		4.5V	0.2	0.26	0.33	0.4	V
		$|I_{OUT}| \le 5.2\ mA$		6.0V	0.2	0.26	0.33	0.4	V
I_{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND		6.0V		±0.1	±1.0	±1.0	μA
I_{CC}	Maximum Quiescent	$V_{IN} = V_{CC}$ or GND		6.0V		2.0	20	40	μA
	Supply Current	$I_{OUT} = 0\ \mu A$							

Note 4: For a power supply of 5V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

$V_{CC} = 5V$, $T_A = 25°C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
t_{PHL}, t_{PLH}	Maximum Propagation Delay		12	20	ns

AC Electrical Characteristics

$V_{CC} = 2.0V$ to $6.0V$, $C_L = 50$ pF, $t_r = t_f = 6$ ns (unless otherwise specified)

Symbol	Parameter	Conditions	V_{CC}	$T_A = 25°C$ Typ	$T_A = 25°C$ Guaranteed Limits	$T_A = -40$ to $85°C$	$T_A = -55$ to $125°C$	Units
t_{PHL}, t_{PLH}	Maximum Propagation Delay		2.0V	63	125	158	186	ns
			4.5V	13	25	32	37	ns
			6.0V	11	21	27	32	ns
t_{TLH}, t_{THL}	Maximum Output Rise and Fall Time		2.0V	30	75	95	110	ns
			4.5V	8	15	19	22	ns
			6.0V	7	13	16	19	ns
C_{PD}	Power Dissipation Capacitance (Note 5)	(per gate)		130				pF
C_{IN}	Maximum Input Capacitance				5	10	10	pF

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.
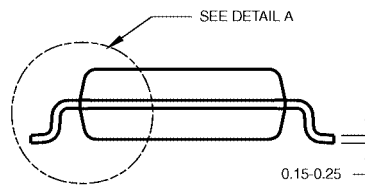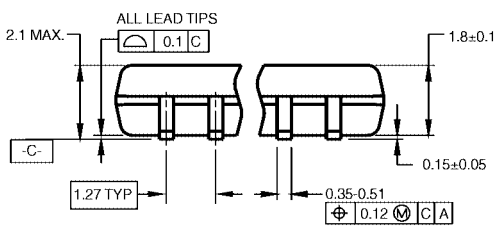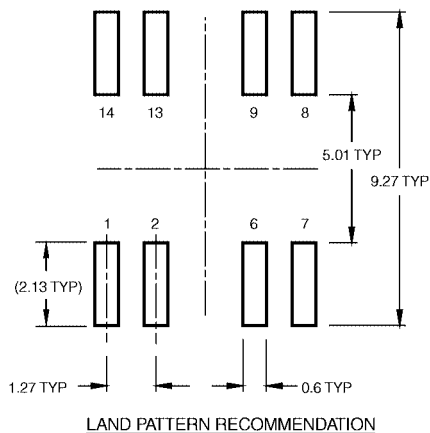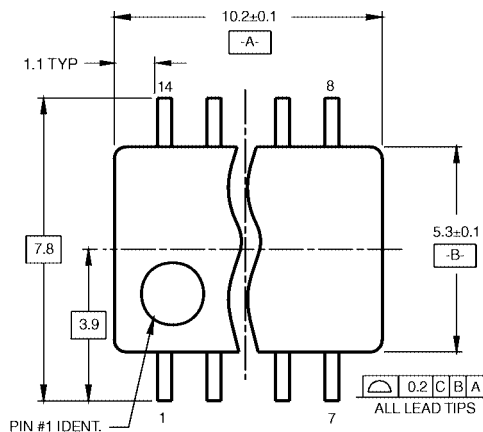
Physical Dimensions inches (millimeters) unless otherwise noted
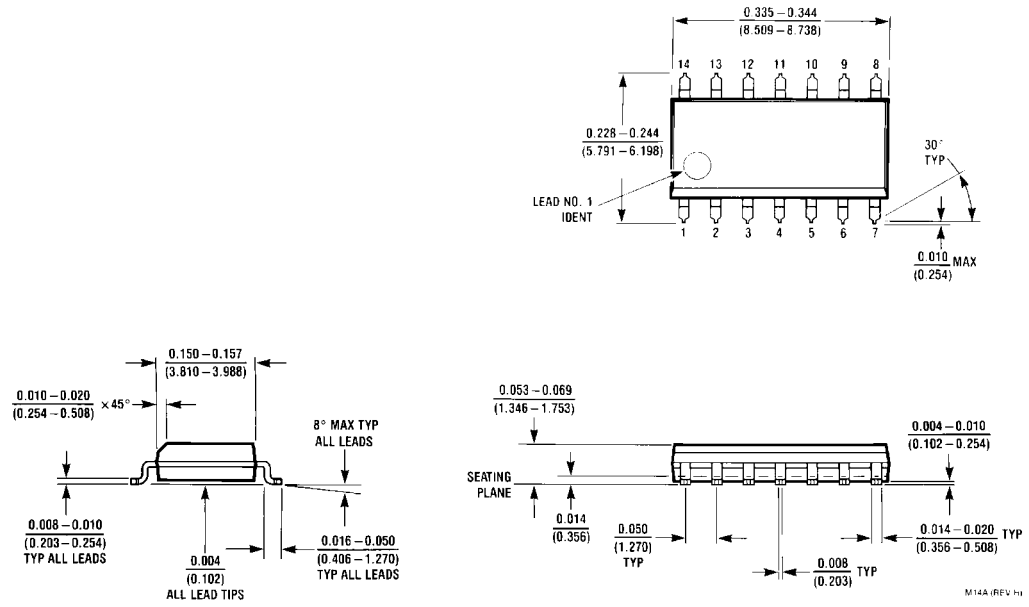
14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
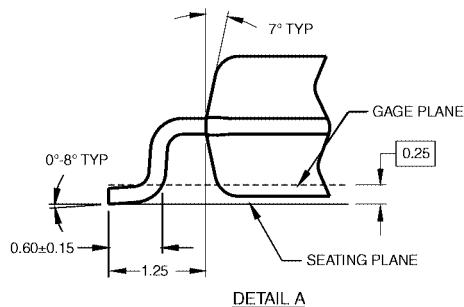**Package Number M14A**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

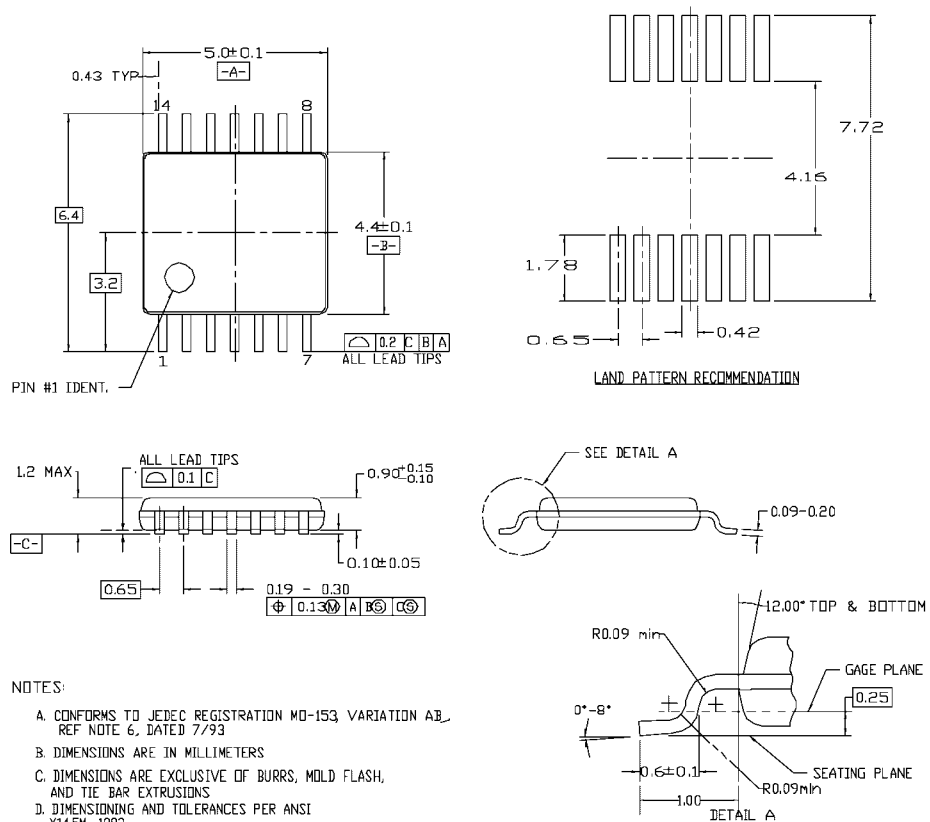LAND PATTERN RECOMMENDATION

DIMENSIONS ARE IN MILLIMETERS

DETAIL A

NOTES:
A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M14DRevB1

Pb-Free 14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M14D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

5.0±0.1
-A-

0.43 TYP

14   8

6.4

3.2

4.4±0.1
-B-

PIN #1 IDENT.

1   7

△ 0.2 C B A
ALL LEAD TIPS

LAND PATTERN RECOMMENDATION

7.72

4.16

1.78

0.65   0.42

1.2 MAX

ALL LEAD TIPS
△ 0.1 C

0.90 +0.15 -0.10

-C-

0.65

0.19 - 0.30
⊕ 0.13Ⓜ A BⓈ CⓈ

0.10±0.05

SEE DETAIL A

0.09-0.20

12.00° TOP & BOTTOM

R0.09 min

GAGE PLANE

0.25

0°-8°

0.6±0.1

1.00

SEATING PLANE

R0.09min

DETAIL A

NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB,
   REF NOTE 6, DATED 7/93

B. DIMENSIONS ARE IN MILLIMETERS

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH,
   AND TIE BAR EXTRUSIONS

D. DIMENSIONING AND TOLERANCES PER ANSI
   Y14.5M, 1982

MTC14revD

14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

OPTION 1

OPTION 02

N14A (REV F)
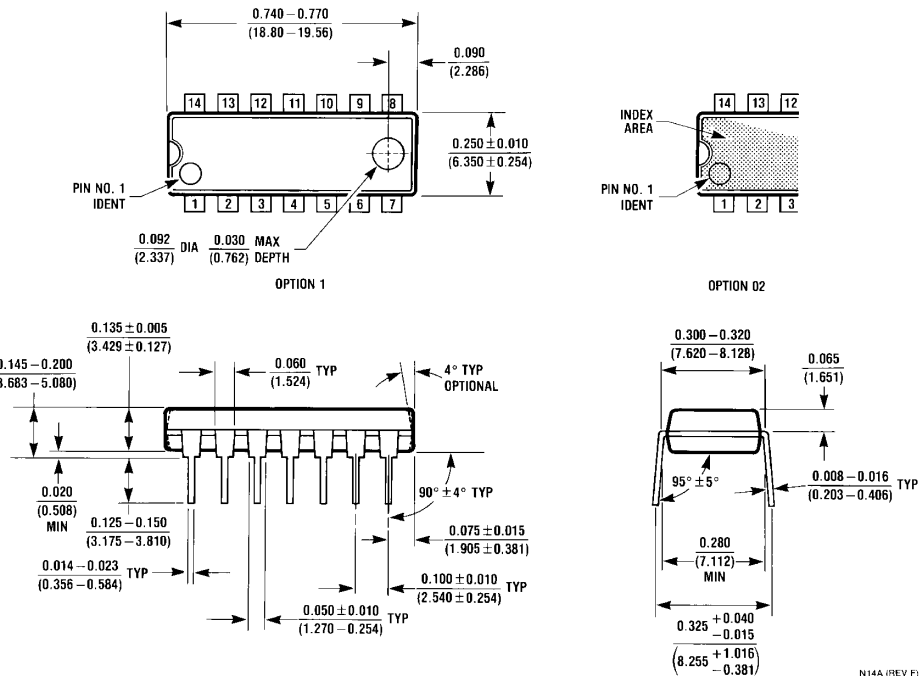
14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N14A

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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